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Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

| | |
|---------------------------------|---|
| Product Status | Obsolete |
| Programmable Type | In System Programmable |
| Delay Time tpd(1) Max | 3 ns |
| Voltage Supply - Internal | 2.3V ~ 2.7V |
| Number of Logic Elements/Blocks | 16 |
| Number of Macrocells | 256 |
| Number of Gates | - |
| Number of I/O | 128 |
| Operating Temperature | 0°C ~ 90°C (TJ) |
| Mounting Type | Surface Mount |
| Package / Case | 176-LQFP |
| Supplier Device Package | 176-TQFP (24x24) |
| Purchase URL | https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4256b-3tn176c |

Table 2. ispMACH 4000Z Family Selection Guide

| | ispMACH 4032ZC | ispMACH 4064ZC | ispMACH 4128ZC | ispMACH 4256ZC |
|-----------------------------------|---------------------|--|----------------------|-----------------------------------|
| Macrocells | 32 | 64 | 128 | 256 |
| I/O + Dedicated Inputs | 32+4/32+4 | 32+4/32+12/ 64+10/64+10 | 64+10/96+4 | 64+10/96+6/ 128+4 |
| t _{PD} (ns) | 3.5 | 3.7 | 4.2 | 4.5 |
| t _S (ns) | 2.2 | 2.5 | 2.7 | 2.9 |
| t _{CO} (ns) | 3.0 | 3.2 | 3.5 | 3.8 |
| f _{MAX} (MHz) | 267 | 250 | 220 | 200 |
| Supply Voltage (V) | 1.8 | 1.8 | 1.8 | 1.8 |
| Max. Standby I _{CC} (μA) | 20 | 25 | 35 | 55 |
| Pins/Package | 48 TQFP 56 csBGA | 48 TQFP 56 csBGA 100 TQFP 132 csBGA | 100 TQFP 132csBGA | 100 TQFP 132 csBGA 176 TQFP |

ispMACH 4000 Introduction

The high performance ispMACH 4000 family from Lattice offers a SuperFAST CPLD solution. The family is a blend of Lattice's two most popular architectures: the ispLSI® 2000 and ispMACH 4A. Retaining the best of both families, the ispMACH 4000 architecture focuses on significant innovations to combine the highest performance with low power in a flexible CPLD family.

The ispMACH 4000 combines high speed and low power with the flexibility needed for ease of design. With its robust Global Routing Pool and Output Routing Pool, this family delivers excellent First-Time-Fit, timing predictability, routing, pin-out retention and density migration.

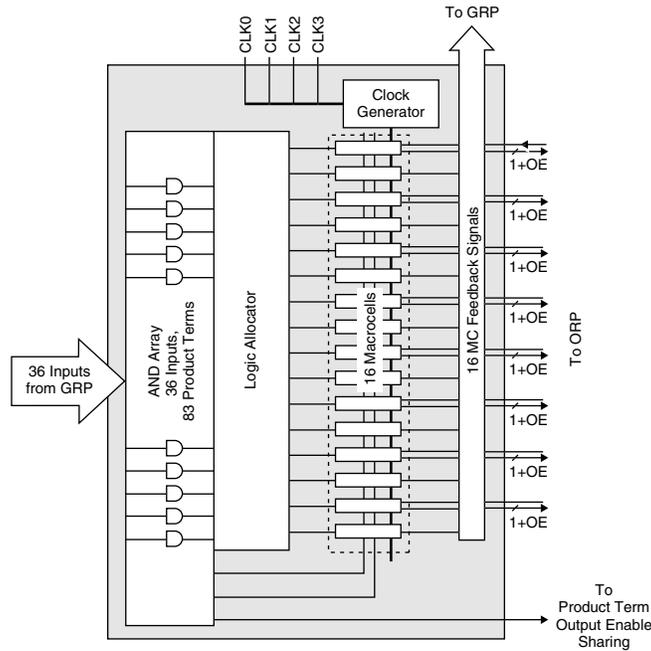
The ispMACH 4000 family offers densities ranging from 32 to 512 macrocells. There are multiple density-I/O combinations in Thin Quad Flat Pack (TQFP), Chip Scale BGA (csBGA) and Fine Pitch Thin BGA (ftBGA) packages ranging from 44 to 256 pins/balls. Table 1 shows the macrocell, package and I/O options, along with other key parameters.

The ispMACH 4000 family has enhanced system integration capabilities. It supports 3.3V (4000V), 2.5V (4000B) and 1.8V (4000C/Z) supply voltages and 3.3V, 2.5V and 1.8V interface voltages. Additionally, inputs can be safely driven up to 5.5V when an I/O bank is configured for 3.3V operation, making this family 5V tolerant. The ispMACH 4000 also offers enhanced I/O features such as slew rate control, PCI compatibility, bus-keeper latches, pull-up resistors, pull-down resistors, open drain outputs and hot socketing. The ispMACH 4000 family members are 3.3V/2.5V/1.8V in-system programmable through the IEEE Standard 1532 interface. IEEE Standard 1149.1 boundary scan testing capability also allows product testing on automated test equipment. The 1532 interface signals TCK, TMS, TDI and TDO are referenced to V_{CC} (logic core).

Overview

The ispMACH 4000 devices consist of multiple 36-input, 16-macrocell Generic Logic Blocks (GLBs) interconnected by a Global Routing Pool (GRP). Output Routing Pools (ORPs) connect the GLBs to the I/O Blocks (IOBs), which contain multiple I/O cells. This architecture is shown in Figure 1.

Figure 2. Generic Logic Block

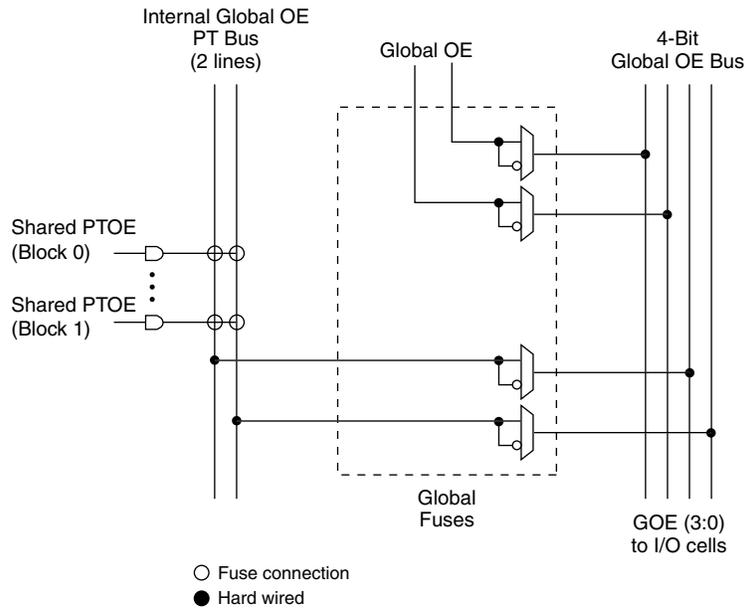


AND Array

The programmable AND Array consists of 36 inputs and 83 output product terms. The 36 inputs from the GRP are used to form 72 lines in the AND Array (true and complement of the inputs). Each line in the array can be connected to any of the 83 output product terms via a wired-AND. Each of the 80 logic product terms feed the logic allocator with the remaining three control product terms feeding the Shared PT Clock, Shared PT Initialization and Shared PT OE. The Shared PT Clock and Shared PT Initialization signals can optionally be inverted before being fed to the macrocells.

Every set of five product terms from the 80 logic product terms forms a product term cluster starting with PT0. There is one product term cluster for every macrocell in the GLB. Figure 3 is a graphical representation of the AND Array.

Figure 10. Global OE Generation for ispMACH 4032



Zero Power/Low Power and Power Management

The ispMACH 4000 family is designed with high speed low power design techniques to offer both high speed and low power. With an advanced E² low power cell and non sense-amplifier design approach (full CMOS logic approach), the ispMACH 4000 family offers SuperFAST pin-to-pin speeds, while simultaneously delivering low standby power without needing any “turbo bits” or other power management schemes associated with a traditional sense-amplifier approach.

The zero power ispMACH 4000Z is based on the 1.8V ispMACH 4000C family. With innovative circuit design changes, the ispMACH 4000Z family is able to achieve the industry’s “lowest static power”.

IEEE 1149.1-Compliant Boundary Scan Testability

All ispMACH 4000 devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more board-level testing. The test access port operates with an LVCMOS interface that corresponds to the power supply voltage.

I/O Quick Configuration

To facilitate the most efficient board test, the physical nature of the I/O cells must be set before running any continuity tests. As these tests are fast, by nature, the overhead and time that is required for configuration of the I/Os’ physical nature should be minimal so that board test time is minimized. The ispMACH 4000 family of devices allows this by offering the user the ability to quickly configure the physical nature of the I/O cells. This quick configuration takes milliseconds to complete, whereas it takes seconds for the entire device to be programmed. Lattice’s ispVM[®] System programming software can either perform the quick configuration through the PC parallel port, or can generate the ATE or test vectors necessary for a third-party test system.

Supply Current, ispMACH 4000Z (Cont.)

Over Recommended Operating Conditions

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|------------------------|--------------------------------|--|------|------|------|-------|
| ispMACH 4256ZC | | | | | | |
| ICC ^{1,2,3,5} | Operating Power Supply Current | V _{CC} = 1.8V, T _A = 25°C | — | 341 | — | μA |
| | | V _{CC} = 1.9V, T _A = 70°C | — | 361 | — | μA |
| | | V _{CC} = 1.9V, T _A = 85°C | — | 372 | — | μA |
| | | V _{CC} = 1.9V, T _A = 125°C | — | 468 | — | μA |
| ICC ^{4,5} | Standby Power Supply Current | V _{CC} = 1.8V, T _A = 25°C | — | 13 | — | μA |
| | | V _{CC} = 1.9V, T _A = 70°C | — | 32 | 55 | μA |
| | | V _{CC} = 1.9V, T _A = 85°C | — | 43 | 90 | μA |
| | | V _{CC} = 1.9V, T _A = 125°C | — | 135 | — | μA |

1. T_A = 25°C, frequency = 1.0 MHz.

2. Device configured with 16-bit counters.

3. I_{CC} varies with specific device configuration and operating frequency.

4. V_{CCO} = 3.6V, V_{IN} = 0V or V_{CCO}, bus maintenance turned off. V_{IN} above V_{CCO} will add transient current above the specified standby I_{CC}.

5. Includes V_{CCO} current without output loading.

I/O DC Electrical Characteristics

Over Recommended Operating Conditions

| Standard | V_{IL} | | V_{IH} | | V_{OL} Max (V) | V_{OH} Min (V) | I_{OL}^1 (mA) | I_{OH}^1 (mA) |
|-------------------------|----------|------------------------------|------------------------------|---------|---------------------|---------------------|--------------------|--------------------|
| | Min (V) | Max (V) | Min (V) | Max (V) | | | | |
| LVTTTL | -0.3 | 0.80 | 2.0 | 5.5 | 0.40 | $V_{CCO} - 0.40$ | 8.0 | -4.0 |
| | | | | | 0.20 | $V_{CCO} - 0.20$ | 0.1 | -0.1 |
| LVCMOS 3.3 | -0.3 | 0.80 | 2.0 | 5.5 | 0.40 | $V_{CCO} - 0.40$ | 8.0 | -4.0 |
| | | | | | 0.20 | $V_{CCO} - 0.20$ | 0.1 | -0.1 |
| LVCMOS 2.5 | -0.3 | 0.70 | 1.70 | 3.6 | 0.40 | $V_{CCO} - 0.40$ | 8.0 | -4.0 |
| | | | | | 0.20 | $V_{CCO} - 0.20$ | 0.1 | -0.1 |
| LVCMOS 1.8 (4000V/B) | -0.3 | 0.63 | 1.17 | 3.6 | 0.40 | $V_{CCO} - 0.45$ | 2.0 | -2.0 |
| | | | | | 0.20 | $V_{CCO} - 0.20$ | 0.1 | -0.1 |
| LVCMOS 1.8 (4000C/Z) | -0.3 | $0.35 * V_{CC}$ | $0.65 * V_{CC}$ | 3.6 | 0.40 | $V_{CCO} - 0.45$ | 2.0 | -2.0 |
| | | | | | 0.20 | $V_{CCO} - 0.20$ | 0.1 | -0.1 |
| PCI 3.3 (4000V/B) | -0.3 | 1.08 | 1.5 | 5.5 | $0.1 V_{CCO}$ | $0.9 V_{CCO}$ | 1.5 | -0.5 |
| PCI 3.3 (4000C/Z) | -0.3 | $0.3 * 3.3 * (V_{CC} / 1.8)$ | $0.5 * 3.3 * (V_{CC} / 1.8)$ | 5.5 | $0.1 V_{CCO}$ | $0.9 V_{CCO}$ | 1.5 | -0.5 |

1. The average DC current drawn by I/Os between adjacent bank GND connections, or between the last GND in an I/O bank and the end of the I/O bank, as shown in the logic signals connection table, shall not exceed $n * 8mA$. Where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

ispMACH 4000V/B/C External Switching Characteristics

Over Recommended Operating Conditions

| Parameter | Description ^{1, 2, 3} | -25 | | -27 | | -3 | | -35 | | Units |
|--|--|------|------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{PD} | 5-PT bypass combinatorial propagation delay | — | 2.5 | — | 2.7 | — | 3.0 | — | 3.5 | ns |
| t _{PD_MC} | 20-PT combinatorial propagation delay through macrocell | — | 3.2 | — | 3.5 | — | 3.8 | — | 4.2 | ns |
| t _S | GLB register setup time before clock | 1.8 | — | 1.8 | — | 2.0 | — | 2.0 | — | ns |
| t _{ST} | GLB register setup time before clock with T-type register | 2.0 | — | 2.0 | — | 2.2 | — | 2.2 | — | ns |
| t _{SIR} | GLB register setup time before clock, input register path | 0.7 | — | 1.0 | — | 1.0 | — | 1.0 | — | ns |
| t _{SIRZ} | GLB register setup time before clock with zero hold | 1.7 | — | 2.0 | — | 2.0 | — | 2.0 | — | ns |
| t _H | GLB register hold time after clock | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t _{HT} | GLB register hold time after clock with T-type register | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t _{HIR} | GLB register hold time after clock, input register path | 0.9 | — | 1.0 | — | 1.0 | — | 1.0 | — | ns |
| t _{HIRZ} | GLB register hold time after clock, input register path with zero hold | 0.0 | — | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t _{CO} | GLB register clock-to-output delay | — | 2.2 | — | 2.7 | — | 2.7 | — | 2.7 | ns |
| t _R | External reset pin to output delay | — | 3.5 | — | 4.0 | — | 4.4 | — | 4.5 | ns |
| t _{RW} | External reset pulse duration | 1.5 | — | 1.5 | — | 1.5 | — | 1.5 | - | ns |
| t _{P_{TOE/DIS}} | Input to output local product term output enable/disable | — | 4.0 | — | 4.5 | — | 5.0 | — | 5.5 | ns |
| t _{G_{P_{TOE/DIS}}} | Input to output global product term output enable/disable | — | 5.0 | — | 6.5 | — | 8.0 | — | 8.0 | ns |
| t _{G_{OE/DIS}} | Global OE input to output enable/disable | — | 3.0 | — | 3.5 | — | 4.0 | — | 4.5 | ns |
| t _{CW} | Global clock width, high or low | 1.1 | — | 1.3 | — | 1.3 | — | 1.3 | — | ns |
| t _{GW} | Global gate width low (for low transparent) or high (for high transparent) | 1.1 | — | 1.3 | — | 1.3 | — | 1.3 | — | ns |
| t _{WIR} | Input register clock width, high or low | 1.1 | — | 1.3 | — | 1.3 | — | 1.3 | — | ns |
| f _{MAX} ⁴ | Clock frequency with internal feedback | — | 400 | — | 333 | — | 322 | — | 322 | MHz |
| f _{MAX} (Ext.) | Clock frequency with external feedback, [1/ (t _S + t _{CO})] | — | 250 | — | 222 | — | 212 | — | 212 | MHz |

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.3.2

2. Measured using standard switching circuit, assuming GRP loading of 1 and 1 output switching.

3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

ispMACH 4000V/B/C External Switching Characteristics (Cont.)

Over Recommended Operating Conditions

| Parameter | Description ^{1, 2, 3} | -5 | | -75 | | -10 | | Units |
|--|--|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{PD} | 5-PT bypass combinatorial propagation delay | — | 5.0 | — | 7.5 | — | 10.0 | ns |
| t _{PD_MC} | 20-PT combinatorial propagation delay through macrocell | — | 5.5 | — | 8.0 | — | 10.5 | ns |
| t _S | GLB register setup time before clock | 3.0 | — | 4.5 | — | 5.5 | — | ns |
| t _{ST} | GLB register setup time before clock with T-type register | 3.2 | — | 4.7 | — | 5.5 | — | ns |
| t _{SIR} | GLB register setup time before clock, input register path | 1.2 | — | 1.7 | — | 1.7 | — | ns |
| t _{SIRZ} | GLB register setup time before clock with zero hold | 2.2 | — | 2.7 | — | 2.7 | — | ns |
| t _H | GLB register hold time after clock | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t _{HT} | GLB register hold time after clock with T-type register | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t _{HIR} | GLB register hold time after clock, input register path | 1.0 | — | 1.0 | — | 1.0 | — | ns |
| t _{HIRZ} | GLB register hold time after clock, input register path with zero hold | 0.0 | — | 0.0 | — | 0.0 | — | ns |
| t _{CO} | GLB register clock-to-output delay | — | 3.4 | — | 4.5 | — | 6.0 | ns |
| t _R | External reset pin to output delay | — | 6.3 | — | 9.0 | — | 10.5 | ns |
| t _{RW} | External reset pulse duration | 2.0 | — | 4.0 | — | 4.0 | — | ns |
| t _{P_{TOE/DIS}} | Input to output local product term output enable/disable | — | 7.0 | — | 9.0 | — | 10.5 | ns |
| t _{G_{P_{TOE/DIS}}} | Input to output global product term output enable/disable | — | 9.0 | — | 10.3 | — | 12.0 | ns |
| t _{G_{OE/DIS}} | Global OE input to output enable/disable | — | 5.0 | — | 7.0 | — | 8.0 | ns |
| t _{CW} | Global clock width, high or low | 2.2 | — | 2.8 | — | 4.0 | — | ns |
| t _{GW} | Global gate width low (for low transparent) or high (for high transparent) | 2.2 | — | 2.8 | — | 4.0 | — | ns |
| t _{WIR} | Input register clock width, high or low | 2.2 | — | 2.8 | — | 4.0 | — | ns |
| f _{MAX} ⁴ | Clock frequency with internal feedback | — | 227 | — | 168 | — | 125 | MHz |
| f _{MAX} (Ext.) | Clock frequency with external feedback, [1/ (t _S + t _{CO})] | — | 156 | — | 111 | — | 86 | MHz |

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards. Timing v.3.2
2. Measured using standard switching circuit, assuming GRP loading of 1 and 1 output switching.
3. Pulse widths and clock widths less than minimum will cause unknown behavior.
4. Standard 16-bit counter using GRP feedback.

ispMACH 4000V/B/C Internal Timing Parameters (Cont.)

Over Recommended Operating Conditions

| Parameter | Description | -5 | | -75 | | -10 | | Units |
|---------------------|-----------------------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{GP} TOE | Global PT OE Delay | — | 5.58 | — | 5.58 | — | 5.78 | ns |
| t _P TOE | Macrocell PT OE Delay | — | 3.58 | — | 4.28 | — | 4.28 | ns |

Timing v.3.2

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the Timing Model in this data sheet for further details.

ispMACH 4000V/B/C Timing Adders¹

| Adder Type | Base Parameter | Description | -25 | | -27 | | -3 | | -35 | | Units |
|---|---|--|------|------|------|------|------|------|------|------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| Optional Delay Adders | | | | | | | | | | | |
| t _{INDIO} | t _{INREG} | Input register delay | — | 0.95 | — | 1.00 | — | 1.00 | — | 1.00 | ns |
| t _{EXP} | t _{MCELL} | Product term expander delay | — | 0.33 | — | 0.33 | — | 0.33 | — | 0.33 | ns |
| t _{ORP} | — | Output routing pool delay | — | 0.05 | — | 0.05 | — | 0.05 | — | 0.05 | ns |
| t _{BLA} | t _{ROUTE} | Additional block loading adder | — | 0.03 | — | 0.05 | — | 0.05 | — | 0.05 | ns |
| t_{IOI} Input Adjusters | | | | | | | | | | | |
| LVTTTL_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVTTTL standard | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVC MOS33_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVC MOS 3.3 standard | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVC MOS25_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVC MOS 2.5 standard | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVC MOS18_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVC MOS 1.8 standard | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| PCI_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using PCI compatible input | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| t_{IOO} Output Adjusters | | | | | | | | | | | |
| LVTTTL_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as TTL buffer | — | 0.20 | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| LVC MOS33_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as 3.3V buffer | — | 0.20 | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| LVC MOS25_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as 2.5V buffer | — | 0.10 | — | 0.10 | — | 0.10 | — | 0.10 | ns |
| LVC MOS18_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as 1.8V buffer | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| PCI_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as PCI compatible buffer | — | 0.20 | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| Slow Slew | t _{BUF} , t _{EN} | Output configured for slow slew rate | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.00 | ns |

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

ispMACH 4000V/B/C Timing Adders¹ (Cont.)

| Adder Type | Base Parameter | Description | -5 | | -75 | | -10 | | Units |
|---|---|--|------|------|------|------|------|------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | |
| Optional Delay Adders | | | | | | | | | |
| t _{INDIO} | t _{INREG} | Input register delay | — | 1.00 | — | 1.00 | — | 1.00 | ns |
| t _{EXP} | t _{MCELL} | Product term expander delay | — | 0.33 | — | 0.33 | — | 0.33 | ns |
| t _{ORP} | — | Output routing pool delay | — | 0.05 | — | 0.05 | — | 0.05 | ns |
| t _{BLA} | t _{ROUTE} | Additional block loading adder | — | 0.05 | — | 0.05 | — | 0.05 | ns |
| t_{IOI} Input Adjusters | | | | | | | | | |
| LVTTTL_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVTTTL standard | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVC MOS33_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVC MOS 3.3 standard | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVC MOS25_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVC MOS 2.5 standard | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVC MOS18_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVC MOS 1.8 standard | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| PCI_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using PCI compatible input | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| t_{IOO} Output Adjusters | | | | | | | | | |
| LVTTTL_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as TTL buffer | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| LVC MOS33_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as 3.3V buffer | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| LVC MOS25_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as 2.5V buffer | — | 0.10 | — | 0.10 | — | 0.10 | ns |
| LVC MOS18_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as 1.8V buffer | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| PCI_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as PCI compatible buffer | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| Slow Slew | t _{BUF} , t _{EN} | Output configured for slow slew rate | — | 1.00 | — | 1.00 | — | 1.00 | ns |

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

ispMACH 4000V/B/C/Z Power Supply and NC Connections¹ (Cont.)

| Signal | 132-ball csBGA ⁷ | 144-pin TQFP ⁴ | 176-pin TQFP ⁴ | 256-ball ftBGA/fpBGA ^{2,3,7,9} |
|------------------------|---|---|---------------------------------------|--|
| VCC | P1, A14, B7, N8 | 36, 57, 108, 129 | 42, 69, 88, 130, 157, 176 | B2, B15, G8, G9, K8, K9, R2, R15 |
| VCCO0 VCCO (Bank 0) | G3, P5, C1 ⁸ , M2 ⁸ , C5 | 3, 19, 34, 47, 136 | 4, 22, 40, 56, 166 | D6, F4, H7, J7, L4, N6 |
| VCCO1 VCCO (Bank 1) | M10, M14 ⁸ , H12, A10, C13 ⁸ | 64, 75, 91, 106, 119 | 78, 92, 110, 128, 144 | D11, F13, H10, J10, L13, N11 |
| GND | B1, P2, N14, A13 | 1, 37, 73, 109 | 2, 46 ⁵ , 65, 90, 134, 153 | A1, A16, C6, C11, F3, F14, G7, G10, H8, H9, J8, J9, K7, K10, L3, L14, P6, P11, T1, T16 |
| GND (Bank 0) | E2, K2, N4, B4 | 10, 18 ⁶ , 27, 46, 127, 137 | 13, 31, 55, 155, 167 | |
| GND (Bank 1) | N11, K13, E13, B11 | 55, 65, 82, 90 ⁶ , 99, 118 | 67, 79, 101, 119, 143 | |
| NC | 4064Z: C1, C3, E1, E3, H2, J3, K1, M2, M4, N5, P7, P8, M8, P10, P11, P14, M12, K14, K12, G13, G14, E14, C13, B13, B10, C10, A7, B5, A5, A4, A1 4128Z: P8, A7 | 4128V: 17, 20, 38, 45, 72, 89, 92, 110, 117, 144 4256V: 18, 90 | 1, 43, 44, 45, 89, 131, 132, 133 | 4256V/B/C, 128 I/O: A4, A5, A6, A11, A12, A13, A15, B5, B6, B11, B12, B14, C7, D1, D4, D5, D10, D12, D16, E1, E2, E4, E5, E7, E10, E13, E14, E15, E16, F1, F2, F15, F16, G1, G4, G5, G6, G12, G13, G14, J11, K3, K4, K15, L1, L2, L12, L15, L16, M1, M2, M3, M4, M5, M12, M13, M15, M16, N1, N2, N7, N10, N12, N14, P5, P12, R4, R5, R6, R11, R12, R16, T2, T4, T5, T6, T11, T12, T13, T15 4256V/B/C, 160 I/O: A5, A12, A15, B5, B6, B11, B12, B14, D4, D5, D12, E1, E4, E5, E13, E15, E16, F1, F2, F15, G1, G5, G12, G14, L1, L2, L12, L15, L16, M1, M2, M3, M12, M16, N1, N12, N14, P5, R4, R5, R6, R11, R12, R16, T4, T5, T12, T15 4384V/B/C: B5, B12, D5, D12, E1, E15, E16, F2, L12, M1, M2, M16, N12, R5, R12, T4 4512V/B/C: None |

1. All grounds must be electrically connected at the board level. However, for the purposes of I/O current loading, grounds are associated with the bank shown.
2. Internal GNDs and I/O GNDs (Bank 0/1) are connected inside package.
3. V_{CCO} balls connect to two power planes within the package, one for V_{CCO0} and one for V_{CCO1}.
4. Pin orientation follows the conventional order from pin 1 marking of the top side view and counter-clockwise.
5. ispMACH 4384V/B/C pin 46 is tied to GND (Bank 0).
6. ispMACH 4128V only.
7. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.
8. ispMACH 4128Z and 4256Z only. NC for ispMACH 4064Z.
9. Use 256 ftBGA package for all new designs. Refer to PCN#14A-07 for 256 fpBGA package discontinuance.

ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections: 100-Pin TQFP (Cont.)

| Pin Number | Bank Number | ispMACH 4064V/B/C/Z | | ispMACH 4128V/B/C/Z | | ispMACH 4256V/B/C/Z | |
|------------|-------------|---------------------|----------------|---------------------|----------------|---------------------|----------------|
| | | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP |
| 83 | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| 84 | 1 | D3 | D ³ | H6 | H ³ | P12 | P ³ |
| 85 | 1 | D2 | D ² | H4 | H ² | P10 | P ² |
| 86 | 1 | D1 | D ¹ | H2 | H ¹ | P6 | P ¹ |
| 87 | 1 | D0/GOE1 | D ⁰ | H0/GOE1 | H ⁰ | P2/OE1 | P ⁰ |
| 88 | 1 | CLK3/I | - | CLK3/I | - | CLK3/I | - |
| 89 | 0 | CLK0/I | - | CLK0/I | - | CLK0/I | - |
| 90 | - | VCC | - | VCC | - | VCC | - |
| 91 | 0 | A0/GOE0 | A ⁰ | A0/GOE0 | A ⁰ | A2/GOE0 | A ⁰ |
| 92 | 0 | A1 | A ¹ | A2 | A ¹ | A6 | A ¹ |
| 93 | 0 | A2 | A ² | A4 | A ² | A10 | A ² |
| 94 | 0 | A3 | A ³ | A6 | A ³ | A12 | A ³ |
| 95 | 0 | VCCO (Bank 0) | - | VCCO (Bank 0) | - | VCCO (Bank 0) | - |
| 96 | 0 | GND (Bank 0) | - | GND (Bank 0) | - | GND (Bank 0) | - |
| 97 | 0 | A4 | A ⁴ | A8 | A ⁴ | B2 | B ⁰ |
| 98 | 0 | A5 | A ⁵ | A10 | A ⁵ | B6 | B ¹ |
| 99 | 0 | A6 | A ⁶ | A12 | A ⁶ | B10 | B ² |
| 100 | 0 | A7 | A ⁷ | A14 | A ⁷ | B12 | B ³ |

*This pin is input only.

ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP

| Pin Number | Bank Number | ispMACH 4128V/B/C | |
|------------|-------------|-------------------|-----------------|
| | | GLB/MC/Pad | ORP |
| 1 | 0 | GND | - |
| 2 | 0 | TDI | - |
| 3 | 0 | VCCO (Bank 0) | - |
| 4 | 0 | B0 | B ⁰ |
| 5 | 0 | B1 | B ¹ |
| 6 | 0 | B2 | B ² |
| 7 | 0 | B4 | B ³ |
| 8 | 0 | B5 | B ⁴ |
| 9 | 0 | B6 | B ⁵ |
| 10 | 0 | GND (Bank 0) | - |
| 11 | 0 | B8 | B ⁶ |
| 12 | 0 | B9 | B ⁷ |
| 13 | 0 | B10 | B ⁸ |
| 14 | 0 | B12 | B ⁹ |
| 15 | 0 | B13 | B ¹⁰ |
| 16 | 0 | B14 | B ¹¹ |
| 17 | 0 | VCCO (Bank 0) | - |
| 18 | 0 | C14 | C ¹¹ |

ispMACH 4128V and 4256V Logic Signal Connections: 144-Pin TQFP (Cont.)

| Pin Number | Bank Number | ispMACH 4128V | | ispMACH 4256V | |
|------------|-------------|-----------------|-------------------|----------------|------------------|
| | | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP |
| 43 | 0 | D9 | D [^] 7 | G4 | G [^] 2 |
| 44 | 0 | D8 | D [^] 6 | G2 | G [^] 1 |
| 45 | 0 | NC ² | - | I ² | - |
| 46 | 0 | GND (Bank 0) | - | GND (Bank 0) | - |
| 47 | 0 | VCCO (Bank 0) | - | VCCO (Bank 0) | - |
| 48 | 0 | D6 | D [^] 5 | H12 | H [^] 6 |
| 49 | 0 | D5 | D [^] 4 | H10 | H [^] 5 |
| 50 | 0 | D4 | D [^] 3 | H8 | H [^] 4 |
| 51 | 0 | D2 | D [^] 2 | H6 | H [^] 3 |
| 52 | 0 | D1 | D [^] 1 | H4 | H [^] 2 |
| 53 | 0 | D0 | D [^] 0 | H2 | H [^] 1 |
| 54 | 0 | CLK1/I | - | CLK1/I | - |
| 55 | 1 | GND (Bank 1) | - | GND (Bank 1) | - |
| 56 | 1 | CLK2/I | - | CLK2/I | - |
| 57 | - | VCC | - | VCC | - |
| 58 | 1 | E0 | E [^] 0 | I2 | I [^] 1 |
| 59 | 1 | E1 | E [^] 1 | I4 | I [^] 2 |
| 60 | 1 | E2 | E [^] 2 | I6 | I [^] 3 |
| 61 | 1 | E4 | E [^] 3 | I8 | I [^] 4 |
| 62 | 1 | E5 | E [^] 4 | I10 | I [^] 5 |
| 63 | 1 | E6 | E [^] 5 | I12 | I [^] 6 |
| 64 | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| 65 | 1 | GND (Bank 1) | - | GND (Bank 1) | - |
| 66 | 1 | E8 | E [^] 6 | J2 | J [^] 1 |
| 67 | 1 | E9 | E [^] 7 | J4 | J [^] 2 |
| 68 | 1 | E10 | E [^] 8 | J6 | J [^] 3 |
| 69 | 1 | E12 | E [^] 9 | J8 | J [^] 4 |
| 70 | 1 | E13 | E [^] 10 | J10 | J [^] 5 |
| 71 | 1 | E14 | E [^] 11 | J12 | J [^] 6 |
| 72 | 1 | NC ² | - | I ² | - |
| 73 | - | GND | - | GND | - |
| 74 | - | TMS | - | TMS | - |
| 75 | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| 76 | 1 | F0 | F [^] 0 | K12 | K [^] 6 |
| 77 | 1 | F1 | F [^] 1 | K10 | K [^] 5 |
| 78 | 1 | F2 | F [^] 2 | K8 | K [^] 4 |
| 79 | 1 | F4 | F [^] 3 | K6 | K [^] 3 |
| 80 | 1 | F5 | F [^] 4 | K4 | K [^] 2 |
| 81 | 1 | F6 | F [^] 5 | K2 | K [^] 1 |
| 82 | 1 | GND (Bank 1) | - | GND (Bank 1) | - |
| 83 | 1 | F8 | F [^] 6 | L14 | L [^] 7 |
| 84 | 1 | F9 | F [^] 7 | L12 | L [^] 6 |
| 85 | 1 | F10 | F [^] 8 | L10 | L [^] 5 |

ispMACH 4000B (2.5V) Commercial Devices (Cont.)

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|-----------------|-------------------------------|------------|---------|-----------------|---------|----------------|-----|-------|
| LC4256B | LC4256B-3FT256AC | 256 | 2.5 | 3 | ftBGA | 256 | 128 | C |
| | LC4256B-5FT256AC | 256 | 2.5 | 5 | ftBGA | 256 | 128 | C |
| | LC4256B-75FT256AC | 256 | 2.5 | 7.5 | ftBGA | 256 | 128 | C |
| | LC4256B-3FT256BC | 256 | 2.5 | 3 | ftBGA | 256 | 160 | C |
| | LC4256B-5FT256BC | 256 | 2.5 | 5 | ftBGA | 256 | 160 | C |
| | LC4256B-75FT256BC | 256 | 2.5 | 7.5 | ftBGA | 256 | 160 | C |
| | LC4256B-3F256AC ¹ | 256 | 2.5 | 3 | fpBGA | 256 | 128 | C |
| | LC4256B-5F256AC ¹ | 256 | 2.5 | 5 | fpBGA | 256 | 128 | C |
| | LC4256B-75F256AC ¹ | 256 | 2.5 | 7.5 | fpBGA | 256 | 128 | C |
| | LC4256B-3F256BC ¹ | 256 | 2.5 | 3 | fpBGA | 256 | 160 | C |
| | LC4256B-5F256BC ¹ | 256 | 2.5 | 5 | fpBGA | 256 | 160 | C |
| | LC4256B-75F256BC ¹ | 256 | 2.5 | 7.5 | fpBGA | 256 | 160 | C |
| | LC4256B-3T176C | 256 | 2.5 | 3 | TQFP | 176 | 128 | C |
| | LC4256B-5T176C | 256 | 2.5 | 5 | TQFP | 176 | 128 | C |
| | LC4256B-75T176C | 256 | 2.5 | 7.5 | TQFP | 176 | 128 | C |
| | LC4256B-3T100C | 256 | 2.5 | 3 | TQFP | 100 | 64 | C |
| LC4256B-5T100C | 256 | 2.5 | 5 | TQFP | 100 | 64 | C | |
| LC4256B-75T100C | 256 | 2.5 | 7.5 | TQFP | 100 | 64 | C | |
| LC4384B | LC4384B-35FT256C | 384 | 2.5 | 3.5 | ftBGA | 256 | 192 | C |
| | LC4384B-5FT256C | 384 | 2.5 | 5 | ftBGA | 256 | 192 | C |
| | LC4384B-75FT256C | 384 | 2.5 | 7.5 | ftBGA | 256 | 192 | C |
| | LC4384B-35F256C ¹ | 384 | 2.5 | 3.5 | fpBGA | 256 | 192 | C |
| | LC4384B-5F256C ¹ | 384 | 2.5 | 5 | fpBGA | 256 | 192 | C |
| | LC4384B-75F256C ¹ | 384 | 2.5 | 7.5 | fpBGA | 256 | 192 | C |
| | LC4384B-35T176C | 384 | 2.5 | 3.5 | TQFP | 176 | 128 | C |
| | LC4384B-5T176C | 384 | 2.5 | 5 | TQFP | 176 | 128 | C |
| | LC4384B-75T176C | 384 | 2.5 | 7.5 | TQFP | 176 | 128 | C |
| LC4512B | LC4512B-35FT256C | 512 | 2.5 | 3.5 | ftBGA | 256 | 208 | C |
| | LC4512B-5FT256C | 512 | 2.5 | 5 | ftBGA | 256 | 208 | C |
| | LC4512B-75FT256C | 512 | 2.5 | 7.5 | ftBGA | 256 | 208 | C |
| | LC4512B-35F256C ¹ | 512 | 2.5 | 3.5 | fpBGA | 256 | 208 | C |
| | LC4512B-5F256C ¹ | 512 | 2.5 | 5 | fpBGA | 256 | 208 | C |
| | LC4512B-75F256C ¹ | 512 | 2.5 | 7.5 | fpBGA | 256 | 208 | C |
| | LC4512B-35T176C | 512 | 2.5 | 3.5 | TQFP | 176 | 128 | C |
| | LC4512B-5T176C | 512 | 2.5 | 5 | TQFP | 176 | 128 | C |
| | LC4512B-75T176C | 512 | 2.5 | 7.5 | TQFP | 176 | 128 | C |

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000B (2.5V) Industrial Devices (Cont.)

| Family | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|------------------------------|------------|---------|-----------------|---------|----------------|-----|-------|
| LC4384B | LC4384B-5FT256I | 384 | 2.5 | 5 | ftBGA | 256 | 192 | I |
| | LC4384B-75FT256I | 384 | 2.5 | 7.5 | ftBGA | 256 | 192 | I |
| | LC4384B-10FT256I | 384 | 2.5 | 10 | ftBGA | 256 | 192 | I |
| | LC4384B-5F256I ¹ | 384 | 2.5 | 5 | fpBGA | 256 | 192 | I |
| | LC4384B-75F256I ¹ | 384 | 2.5 | 7.5 | fpBGA | 256 | 192 | I |
| | LC4384B-10F256I ¹ | 384 | 2.5 | 10 | fpBGA | 256 | 192 | I |
| | LC4384B-5T176I | 384 | 2.5 | 5 | TQFP | 176 | 128 | I |
| | LC4384B-75T176I | 384 | 2.5 | 7.5 | TQFP | 176 | 128 | I |
| | LC4384B-10T176I | 384 | 2.5 | 10 | TQFP | 176 | 128 | I |
| LC4512B | LC4512B-5FT256I | 512 | 2.5 | 5 | ftBGA | 256 | 208 | I |
| | LC4512B-75FT256I | 512 | 2.5 | 7.5 | ftBGA | 256 | 208 | I |
| | LC4512B-10FT256I | 512 | 2.5 | 10 | ftBGA | 256 | 208 | I |
| | LC4512B-5F256I ¹ | 512 | 2.5 | 5 | fpBGA | 256 | 208 | I |
| | LC4512B-75F256I ¹ | 512 | 2.5 | 7.5 | fpBGA | 256 | 208 | I |
| | LC4512B-10F256I ¹ | 512 | 2.5 | 10 | fpBGA | 256 | 208 | I |
| | LC4512B-5T176I | 512 | 2.5 | 5 | TQFP | 176 | 128 | I |
| | LC4512B-75T176I | 512 | 2.5 | 7.5 | TQFP | 176 | 128 | I |
| | LC4512B-10T176I | 512 | 2.5 | 10 | TQFP | 176 | 128 | I |

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000V (3.3V) Commercial Devices

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|----------------|-----------------|------------|---------|-----------------|---------|----------------|-----|-------|
| LC4032V | LC4032V-25T48C | 32 | 3.3 | 2.5 | TQFP | 48 | 32 | C |
| | LC4032V-5T48C | 32 | 3.3 | 5 | TQFP | 48 | 32 | C |
| | LC4032V-75T48C | 32 | 3.3 | 7.5 | TQFP | 48 | 32 | C |
| | LC4032V-25T44C | 32 | 3.3 | 2.5 | TQFP | 44 | 30 | C |
| | LC4032V-5T44C | 32 | 3.3 | 5 | TQFP | 44 | 30 | C |
| | LC4032V-75T44C | 32 | 3.3 | 7.5 | TQFP | 44 | 30 | C |
| LC4064V | LC4064V-25T100C | 64 | 3.3 | 2.5 | TQFP | 100 | 64 | C |
| | LC4064V-5T100C | 64 | 3.3 | 5 | TQFP | 100 | 64 | C |
| | LC4064V-75T100C | 64 | 3.3 | 7.5 | TQFP | 100 | 64 | C |
| | LC4064V-25T48C | 64 | 3.3 | 2.5 | TQFP | 48 | 32 | C |
| | LC4064V-5T48C | 64 | 3.3 | 5 | TQFP | 48 | 32 | C |
| | LC4064V-75T48C | 64 | 3.3 | 7.5 | TQFP | 48 | 32 | C |
| | LC4064V-25T44C | 64 | 3.3 | 2.5 | TQFP | 44 | 30 | C |
| | LC4064V-5T44C | 64 | 3.3 | 5 | TQFP | 44 | 30 | C |
| LC4064V-75T44C | 64 | 3.3 | 7.5 | TQFP | 44 | 30 | C | |

ispMACH 4000V (3.3V) Commercial Devices (Cont.)

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|-----------------|-------------------------------|------------|---------|-----------------|---------|----------------|-----|-------|
| LC4128V | LC4128V-27T144C | 128 | 3.3 | 2.7 | TQFP | 144 | 96 | C |
| | LC4128V-5T144C | 128 | 3.3 | 5 | TQFP | 144 | 96 | C |
| | LC4128V-75T144C | 128 | 3.3 | 7.5 | TQFP | 144 | 96 | C |
| | LC4128V-27T128C | 128 | 3.3 | 2.7 | TQFP | 128 | 92 | C |
| | LC4128V-5T128C | 128 | 3.3 | 5 | TQFP | 128 | 92 | C |
| | LC4128V-75T128C | 128 | 3.3 | 7.5 | TQFP | 128 | 92 | C |
| | LC4128V-27T100C | 128 | 3.3 | 2.7 | TQFP | 100 | 64 | C |
| | LC4128V-5T100C | 128 | 3.3 | 5 | TQFP | 100 | 64 | C |
| | LC4128V-75T100C | 128 | 3.3 | 7.5 | TQFP | 100 | 64 | C |
| LC4256V | LC4256V-3FT256AC | 256 | 3.3 | 3 | ftBGA | 256 | 128 | C |
| | LC4256V-5FT256AC | 256 | 3.3 | 5 | ftBGA | 256 | 128 | C |
| | LC4256V-75FT256AC | 256 | 3.3 | 7.5 | ftBGA | 256 | 128 | C |
| | LC4256V-3FT256BC | 256 | 3.3 | 3 | ftBGA | 256 | 160 | C |
| | LC4256V-5FT256BC | 256 | 3.3 | 5 | ftBGA | 256 | 160 | C |
| | LC4256V-75FT256BC | 256 | 3.3 | 7.5 | ftBGA | 256 | 160 | C |
| | LC4256V-3F256AC ¹ | 256 | 3.3 | 3 | fpBGA | 256 | 128 | C |
| | LC4256V-5F256AC ¹ | 256 | 3.3 | 5 | fpBGA | 256 | 128 | C |
| | LC4256V-75F256AC ¹ | 256 | 3.3 | 7.5 | fpBGA | 256 | 128 | C |
| | LC4256V-3F256BC ¹ | 256 | 3.3 | 3 | fpBGA | 256 | 160 | C |
| | LC4256V-5F256BC ¹ | 256 | 3.3 | 5 | fpBGA | 256 | 160 | C |
| | LC4256V-75F256BC ¹ | 256 | 3.3 | 7.5 | fpBGA | 256 | 160 | C |
| | LC4256V-3T176C | 256 | 3.3 | 3 | TQFP | 176 | 128 | C |
| | LC4256V-5T176C | 256 | 3.3 | 5 | TQFP | 176 | 128 | C |
| | LC4256V-75T176C | 256 | 3.3 | 7.5 | TQFP | 176 | 128 | C |
| | LC4256V-3T144C | 256 | 3.3 | 3 | TQFP | 144 | 96 | C |
| | LC4256V-5T144C | 256 | 3.3 | 5 | TQFP | 144 | 96 | C |
| | LC4256V-75T144C | 256 | 3.3 | 7.5 | TQFP | 144 | 96 | C |
| | LC4256V-3T100C | 256 | 3.3 | 3 | TQFP | 100 | 64 | C |
| | LC4256V-5T100C | 256 | 3.3 | 5 | TQFP | 100 | 64 | C |
| LC4256V-75T100C | 256 | 3.3 | 7.5 | TQFP | 100 | 64 | C | |
| LC4384V | LC4384V-35FT256C | 384 | 3.3 | 3.5 | ftBGA | 256 | 192 | C |
| | LC4384V-5FT256C | 384 | 3.3 | 5 | ftBGA | 256 | 192 | C |
| | LC4384V-75FT256C | 384 | 3.3 | 7.5 | ftBGA | 256 | 192 | C |
| | LC4384V-35F256C ¹ | 384 | 3.3 | 3.5 | fpBGA | 256 | 192 | C |
| | LC4384V-5F256C ¹ | 384 | 3.3 | 5 | fpBGA | 256 | 192 | C |
| | LC4384V-75F256C ¹ | 384 | 3.3 | 7.5 | fpBGA | 256 | 192 | C |
| | LC4384V-35T176C | 384 | 3.3 | 3.5 | TQFP | 176 | 128 | C |
| | LC4384V-5T176C | 384 | 3.3 | 5 | TQFP | 176 | 128 | C |
| | LC4384V-75T176C | 384 | 3.3 | 7.5 | TQFP | 176 | 128 | C |

ispMACH 4000V (3.3V) Extended Temperature Devices

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|-----------------|------------|---------|-----------------|---------|----------------|-----|-------|
| LC4032V | LC4032V-75T48E | 32 | 3.3 | 7.5 | TQFP | 48 | 32 | E |
| | LC4032V-75T44E | 32 | 3.3 | 7.5 | TQFP | 44 | 30 | E |
| LC4064V | LC4064V-75T100E | 64 | 3.3 | 7.5 | TQFP | 100 | 64 | E |
| | LC4064V-75T48E | 64 | 3.3 | 7.5 | TQFP | 48 | 32 | E |
| | LC4064V-75T44E | 64 | 3.3 | 7.5 | TQFP | 44 | 30 | E |
| LC4128V | LC4128V-75T144E | 128 | 3.3 | 7.5 | TQFP | 144 | 96 | E |
| | LC4128V-75T128E | 128 | 3.3 | 7.5 | TQFP | 128 | 92 | E |
| | LC4128V-75T100E | 128 | 3.3 | 7.5 | TQFP | 100 | 64 | E |
| LC4256V | LC4256V-75T176E | 256 | 3.3 | 7.5 | TQFP | 176 | 128 | E |
| | LC4256V-75T144E | 256 | 3.3 | 7.5 | TQFP | 144 | 96 | E |
| | LC4256V-75T100E | 256 | 3.3 | 7.5 | TQFP | 100 | 64 | E |

ispMACH 4000C (1.8V) Lead-Free Commercial Devices (Cont.)

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|------------------|--------------------------------|------------|---------|-----------------|-----------------|----------------|-----|-------|
| LC4064C | LC4064C-25TN100C | 64 | 1.8 | 2.5 | Lead-free TQFP | 100 | 64 | C |
| | LC4064C-5TN100C | 64 | 1.8 | 5 | Lead-free TQFP | 100 | 64 | C |
| | LC4064C-75TN100C | 64 | 1.8 | 7.5 | Lead-free TQFP | 100 | 64 | C |
| | LC4064C-25TN48C | 64 | 1.8 | 2.5 | Lead-free TQFP | 48 | 32 | C |
| | LC4064C-5TN48C | 64 | 1.8 | 5 | Lead-free TQFP | 48 | 32 | C |
| | LC4064C-75TN48C | 64 | 1.8 | 7.5 | Lead-free TQFP | 48 | 32 | C |
| | LC4064C-25TN44C | 64 | 1.8 | 2.5 | Lead-free TQFP | 44 | 30 | C |
| | LC4064C-5TN44C | 64 | 1.8 | 5 | Lead-free TQFP | 44 | 30 | C |
| LC4128C | LC4128C-27TN128C | 128 | 1.8 | 2.7 | Lead-free TQFP | 128 | 92 | C |
| | LC4128C-5TN128C | 128 | 1.8 | 5 | Lead-free TQFP | 128 | 92 | C |
| | LC4128C-75TN128C | 128 | 1.8 | 7.5 | Lead-free TQFP | 128 | 92 | C |
| | LC4128C-27TN100C | 128 | 1.8 | 2.7 | Lead-free TQFP | 100 | 64 | C |
| | LC4128C-5TN100C | 128 | 1.8 | 5 | Lead-free TQFP | 100 | 64 | C |
| | LC4128C-75TN100C | 128 | 1.8 | 7.5 | Lead-free TQFP | 100 | 64 | C |
| LC4256C | LC4256C-3FTN256AC | 256 | 1.8 | 3 | Lead-free ftBGA | 256 | 128 | C |
| | LC4256C-5FTN256AC | 256 | 1.8 | 5 | Lead-free ftBGA | 256 | 128 | C |
| | LC4256C-75FTN256AC | 256 | 1.8 | 7.5 | Lead-free ftBGA | 256 | 128 | C |
| | LC4256C-3FTN256BC | 256 | 1.8 | 3 | Lead-free ftBGA | 256 | 160 | C |
| | LC4256C-5FTN256BC | 256 | 1.8 | 5 | Lead-free ftBGA | 256 | 160 | C |
| | LC4256C-75FTN256BC | 256 | 1.8 | 7.5 | Lead-free ftBGA | 256 | 160 | C |
| | LC4256C-3FN256AC ¹ | 256 | 1.8 | 3 | Lead-free fpBGA | 256 | 128 | C |
| | LC4256C-5FN256AC ¹ | 256 | 1.8 | 5 | Lead-free fpBGA | 256 | 128 | C |
| | LC4256C-75FN256AC ¹ | 256 | 1.8 | 7.5 | Lead-free fpBGA | 256 | 128 | C |
| | LC4256C-3FN256BC ¹ | 256 | 1.8 | 3 | Lead-free fpBGA | 256 | 160 | C |
| | LC4256C-5FN256BC ¹ | 256 | 1.8 | 5 | Lead-free fpBGA | 256 | 160 | C |
| | LC4256C-75FN256BC ¹ | 256 | 1.8 | 7.5 | Lead-free fpBGA | 256 | 160 | C |
| | LC4256C-3TN176C | 256 | 1.8 | 3 | Lead-free TQFP | 176 | 128 | C |
| | LC4256C-5TN176C | 256 | 1.8 | 5 | Lead-free TQFP | 176 | 128 | C |
| | LC4256C-75TN176C | 256 | 1.8 | 7.5 | Lead-free TQFP | 176 | 128 | C |
| | LC4256C-3TN100C | 256 | 1.8 | 3 | Lead-free TQFP | 100 | 64 | C |
| LC4256C-5TN100C | 256 | 1.8 | 5 | Lead-free TQFP | 100 | 64 | C | |
| LC4256C-75TN100C | 256 | 1.8 | 7.5 | Lead-free TQFP | 100 | 64 | C | |
| LC4384C | LC4384C-35FTN256C | 384 | 1.8 | 3.5 | Lead-free ftBGA | 256 | 192 | C |
| | LC4384C-5FTN256C | 384 | 1.8 | 5 | Lead-free ftBGA | 256 | 192 | C |
| | LC4384C-75FTN256C | 384 | 1.8 | 7.5 | Lead-free ftBGA | 256 | 192 | C |
| | LC4384C-35FN256C ¹ | 384 | 1.8 | 3.5 | Lead-free fpBGA | 256 | 192 | C |
| | LC4384C-5FN256C ¹ | 384 | 1.8 | 5 | Lead-free fpBGA | 256 | 192 | C |
| | LC4384C-75FN256C ¹ | 384 | 1.8 | 7.5 | Lead-free fpBGA | 256 | 192 | C |
| | LC4384C-35TN176C | 384 | 1.8 | 3.5 | Lead-free TQFP | 176 | 128 | C |
| | LC4384C-5TN176C | 384 | 1.8 | 5 | Lead-free TQFP | 176 | 128 | C |
| LC4384C-75TN176C | 384 | 1.8 | 7.5 | Lead-free TQFP | 176 | 128 | C | |

ispMACH 4000B (2.5V) Lead-Free Commercial Devices (Cont.)

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|-------------------------------|------------|---------|-----------------|-----------------|----------------|-----|-------|
| LC4384B | LC4384B-35FTN256C | 384 | 2.5 | 3.5 | Lead-Free ftBGA | 256 | 192 | C |
| | LC4384B-5FTN256C | 384 | 2.5 | 5 | Lead-Free ftBGA | 256 | 192 | C |
| | LC4384B-75FTN256C | 384 | 2.5 | 7.5 | Lead-Free ftBGA | 256 | 192 | C |
| | LC4384B-35FN256C ¹ | 384 | 2.5 | 3.5 | Lead-Free fpBGA | 256 | 192 | C |
| | LC4384B-5FN256C ¹ | 384 | 2.5 | 5 | Lead-Free fpBGA | 256 | 192 | C |
| | LC4384B-75FN256C ¹ | 384 | 2.5 | 7.5 | Lead-Free fpBGA | 256 | 192 | C |
| | LC4384B-35TN176C | 384 | 2.5 | 3.5 | Lead-Free TQFP | 176 | 128 | C |
| | LC4384B-5TN176C | 384 | 2.5 | 5 | Lead-Free TQFP | 176 | 128 | C |
| LC4512B | LC4512B-35FTN256C | 512 | 2.5 | 3.5 | Lead-Free ftBGA | 256 | 208 | C |
| | LC4512B-5FTN256C | 512 | 2.5 | 5 | Lead-Free ftBGA | 256 | 208 | C |
| | LC4512B-75FTN256C | 512 | 2.5 | 7.5 | Lead-Free ftBGA | 256 | 208 | C |
| | LC4512B-35FN256C ¹ | 512 | 2.5 | 3.5 | Lead-Free fpBGA | 256 | 208 | C |
| | LC4512B-5FN256C ¹ | 512 | 2.5 | 5 | Lead-Free fpBGA | 256 | 208 | C |
| | LC4512B-75FN256C ¹ | 512 | 2.5 | 7.5 | Lead-Free fpBGA | 256 | 208 | C |
| | LC4512B-35TN176C | 512 | 2.5 | 3.5 | Lead-Free TQFP | 176 | 128 | C |
| | LC4512B-5TN176C | 512 | 2.5 | 5 | Lead-Free TQFP | 176 | 128 | C |
| | LC4512B-75TN176C | 512 | 2.5 | 7.5 | Lead-Free TQFP | 176 | 128 | C |

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000B (2.5V) Lead-Free Industrial Devices

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|------------------|------------|---------|-----------------|----------------|----------------|-----|-------|
| LC4032B | LC4032B-5TN48I | 32 | 2.5 | 5 | Lead-Free TQFP | 48 | 32 | I |
| | LC4032B-75TN48I | 32 | 2.5 | 7.5 | Lead-Free TQFP | 48 | 32 | I |
| | LC4032B-10TN48I | 32 | 2.5 | 10 | Lead-Free TQFP | 48 | 32 | I |
| | LC4032B-5TN44I | 32 | 2.5 | 5 | Lead-Free TQFP | 44 | 30 | I |
| | LC4032B-75TN44I | 32 | 2.5 | 7.5 | Lead-Free TQFP | 44 | 30 | I |
| | LC4032B-10TN44I | 32 | 2.5 | 10 | Lead-Free TQFP | 44 | 30 | I |
| LC4064B | LC4064B-5TN100I | 64 | 2.5 | 5 | Lead-Free TQFP | 100 | 64 | I |
| | LC4064B-75TN100I | 64 | 2.5 | 7.5 | Lead-Free TQFP | 100 | 64 | I |
| | LC4064B-10TN100I | 64 | 2.5 | 10 | Lead-Free TQFP | 100 | 64 | I |
| | LC4064B-5TN48I | 64 | 2.5 | 5 | Lead-Free TQFP | 48 | 32 | I |
| | LC4064B-75TN48I | 64 | 2.5 | 7.5 | Lead-Free TQFP | 48 | 32 | I |
| | LC4064B-10TN48I | 64 | 2.5 | 10 | Lead-Free TQFP | 48 | 32 | I |
| | LC4064B-5TN44I | 64 | 2.5 | 5 | Lead-Free TQFP | 44 | 30 | I |
| | LC4064B-75TN44I | 64 | 2.5 | 7.5 | Lead-Free TQFP | 44 | 30 | I |
| | LC4064B-10TN44I | 64 | 2.5 | 10 | Lead-Free TQFP | 44 | 30 | I |

ispMACH 4000V (3.3V) Lead-Free Industrial Devices

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|------------------|------------------|------------|---------|-----------------|----------------|----------------|-----|-------|
| LC4032V | LC4032V-5TN48I | 32 | 3.3 | 5 | Lead-free TQFP | 48 | 32 | I |
| | LC4032V-75TN48I | 32 | 3.3 | 7.5 | Lead-free TQFP | 48 | 32 | I |
| | LC4032V-10TN48I | 32 | 3.3 | 10 | Lead-free TQFP | 48 | 32 | I |
| | LC4032V-5TN44I | 32 | 3.3 | 5 | Lead-free TQFP | 44 | 30 | I |
| | LC4032V-75TN44I | 32 | 3.3 | 7.5 | Lead-free TQFP | 44 | 30 | I |
| | LC4032V-10TN44I | 32 | 3.3 | 10 | Lead-free TQFP | 44 | 30 | I |
| LC4064V | LC4064V-5TN100I | 64 | 3.3 | 5 | Lead-free TQFP | 100 | 64 | I |
| | LC4064V-75TN100I | 64 | 3.3 | 7.5 | Lead-free TQFP | 100 | 64 | I |
| | LC4064V-10TN100I | 64 | 3.3 | 10 | Lead-free TQFP | 100 | 64 | I |
| | LC4064V-5TN48I | 64 | 3.3 | 5 | Lead-free TQFP | 48 | 32 | I |
| | LC4064V-75TN48I | 64 | 3.3 | 7.5 | Lead-free TQFP | 48 | 32 | I |
| | LC4064V-10TN48I | 64 | 3.3 | 10 | Lead-free TQFP | 48 | 32 | I |
| | LC4064V-5TN44I | 64 | 3.3 | 5 | Lead-free TQFP | 44 | 30 | I |
| | LC4064V-75TN44I | 64 | 3.3 | 7.5 | Lead-free TQFP | 44 | 30 | I |
| LC4128V | LC4128V-10TN44I | 64 | 3.3 | 10 | Lead-free TQFP | 44 | 30 | I |
| | LC4128V-5TN144I | 128 | 3.3 | 5 | Lead-free TQFP | 144 | 96 | I |
| | LC4128V-75TN144I | 128 | 3.3 | 7.5 | Lead-free TQFP | 144 | 96 | I |
| | LC4128V-10TN144I | 128 | 3.3 | 10 | Lead-free TQFP | 144 | 96 | I |
| | LC4128V-5TN128I | 128 | 3.3 | 5 | Lead-free TQFP | 128 | 92 | I |
| | LC4128V-75TN128I | 128 | 3.3 | 7.5 | Lead-free TQFP | 128 | 92 | I |
| | LC4128V-10TN128I | 128 | 3.3 | 10 | Lead-free TQFP | 128 | 92 | I |
| | LC4128V-5TN100I | 128 | 3.3 | 5 | Lead-free TQFP | 100 | 64 | I |
| | LC4128V-75TN100I | 128 | 3.3 | 7.5 | Lead-free TQFP | 100 | 64 | I |
| LC4128V-10TN100I | 128 | 3.3 | 10 | Lead-free TQFP | 100 | 64 | I | |